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Change in Menu Project

Quantity	Designator	Value	Description	PackageReference	PartNumber	Manufacturer
4	C1, C9, C16, C23	68uF	CAP_POSCAP_D	7343(D)	16TQC68M	Sanyo
4	C2, C10, C17, C24	47uf	C1210	1210	GRM32ER61E226K	Murata
27	C25, C26, C27, C26	47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 47uF, 100nF, 100nF, 1nF, 10uF, 10uF, 10uF, 10uF, 10uF, 10pF, 0.1uF, 10uF		1210	GRM32ER60J476M	Murata
4	C7, C15, C22, C29	220 uF	CAP_T520-7343	7343(D)	T530D337M006ATE006	Kemet
26		12.1k, 50, 1.74K, 68.1k, 12.1k, 50, 0.453K, 50, 1.74K, 50, 1.74K, 10K, 1K, 10K, 10K, 1K, 1K, 1K, 10K, 10K, 10, 100K, 324K, 324K, 324K, 324K	C603, R0603_1%,	0603	Std	Std
1	D1	5.1V	D-BZT52CXXXS	SOD-323	BZT52C5V1S	Diodes Inc.
2		0.65V	Diode, Schottky, 30V, 0.2A, SOT-23	SOT-23	BAT54-7-F	Diodes Inc.
1	J1		TBLK_6A_2X3.5MM	0.27 x 0.25 inch	ED555/2DS	OST
5	J2, J3, J4, J5, J6		TBLK_15A_2X5.1MM	0.40 x 0.35 inch	ED120/2DS	OST
4	TP1, TP3, TP5, TP7	5013	TP-5013-ORANGE	0.125 x 0.125 inch	5013	Keystone
4	TP2, TP4, TP6, TP8	5010	TP-5010-RED	0.125 x 0.125 inch	5010	Keystone
2	U1, U2	TPS84621RUQ	Synchronous Buck	QFN	TPS84621RUQ	ТІ
2	U3, U4	1PS84320RUQ	Synchronous Buck	QFN	TPS84320RUQ	ТІ
1	U5		IC, Sink/Source DDR Termination Regulator	DRC	TPS51200DRC	ТІ
1	U6	SN74LVC1G14DCK	IC, Single Schmitt-Trigger Inverter	DCK-5	SN74LVC1G14DCK	ті

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